

THERMAL PRINT HEAD SPECIFICATION

Model No

G104-4I



HEC SHANDONG HUALING ELECTRONICS CO., LTD.

REVISION					<u>Approved</u>
Rev	Description	Date	Approved	Drawn	
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1. Description

This specification is applied to G104-4I thermal print head.

2. Scope

The G104-4I is a thermal print head which has heat elements which produce 832 dots with 8 dots/mm by means of a high density thick film process. It also includes G-MOS ICs; Which operate as 832 bits shift-registers, latches and switching transistors to drive heat elements.

3. Outline

Item	Specification	Note
Dimension	Fig.5	
Schematic diagram	Fig.3	
Pin assignment	Table.3	
Print width	104 mm	
Number of heaters	832 dots	
Heater resolution	8 dots/mm	
Heater pitch	0.125 mm	
Printed dot dimension	0.11mm×0.13 mm	Nominal
Heater resistance	$\bar{R} = 700 \Omega \pm 3 \%$	
Specifications for driver ICs	Table.2	
Number of driver ICs	64bits × 13	
Number of data inputs	4 parallel input	
Number of strobes	4	
Logic power supply	5 V × 59 mA	at 2 MHz
Specification for Thermistor	$R_{25} = 30K \Omega \pm 5\%, B = 3,950K \pm 2\%$	Table. 1

4. Maximum ratings

Parameter	Symbol	Specification	Note
Heater energy consumption	Eomax	0.27 mJ/dot	2.5 ms/line
		0.18 mJ/dot	1.25 ms/line
		0.15 mJ/dot	0.625 ms/line
Head voltage	VH	25.2 V	Between Connectors
Logic voltage	Vdd	Vdd=+5V±0.25V	
Environment temperature	Ta	+5 ° C ~ +50 ° C	Operating
		- 40 ° C ~ +80 ° C	Non-operating
Environment humidity		10 ~ 90%RH	Non-condensing
Maximum operating temperature	Ts	65 ° C 30min. MAX	
		Detected temperature of Thermistor shall not exceed 65 ° C.	Head temperature shall not exceed 70 ° C.

5. Standard printing conditions

Parameter	Symbol	Recommended operating conditions		Note
Speed		0.625 ms/line	1.25 ms/line	
		8 inch/sec	4 inch/sec	
Heater power consumption	Po	0.74 W/dot		$\bar{R} = 700 \Omega$
Heat voltage	VH	24 V		Connectors
Heater energy consumption	Eo (ts)	0.15mJ/dot (0.20 ms)	0.18mJ/dot (0.24 ms)	$\bar{R} = 700 \Omega$ (Note 1)
		0.14mJ/dot (0.19 ms)	0.15mJ/dot (0.20 ms)	
		0.13mJ/dot (0.18 ms)	0.14mJ/dot (0.19 ms)	
Supply current	Io	31.0 mA/dot		$\bar{R} = 700 \Omega$
Timing chart		Fig. 2		
Platen pressure		13.7 ~ 18.6 N / TPH		
Platen hardness		30~40deg		
Platen diameter		$\Phi 14$ Max.		
Scanning resolution		8 line/mm		
Thermal paper		F24OAC / F220-VP MITSUBISHI PAPER MILL CO., LTD.		
Optical density		1.1 OD Min.		(Note 2)

(Note 1) Supply energy is defined by the following formula.

$$E_o = I_o^2 \bar{R} t_s = \frac{(VH - V_{com})^2 \cdot \bar{R} \cdot t_s}{(\bar{R} + R_{ic})^2}$$

$R_{ic} = 23 \Omega$: Driver IC "ON" resistance

t_s : Strobe printing pulse width

VH : Heat voltage

$\bar{R}$: Heater average resistance

$V_{com} = 0.5V$: Common electrode voltage drop

(Note 2) Printed optical density is measured at 10mm intervals after the starting point. Printed optical density is measured by a RD-914 reflector optical density meter or equivalent .

6. Life expectancy

6.1 The life expectancy under 12.5% printing duty of less at 25° C is defined by the following whichever earlier comes.

Item	Specification	Note
Number of pulses	1×10^8 pulses	
Run length	100 Km	

6.2 Under 10% humidity, the platen roller which is protected by a rubber insulator, will operate under test conditions with no paper for a maximum of 3Km, before the heat element fails.

7. Warning during use

7.1 Strobe signal

During head power supply ON/OFF sequence strobes should be kept "disable".

7.2 Stability of IC operation

Care should be taken for stable operation of driver ICs as indicated bellow. (Fig.1)

- (1) If the voltage including surge exceeds maximum rating of driver IC, the TPH may burn out by latch-up. Care should be taken especially when head current changes by strobes or at the ON/OFF sequence. The voltage shall be kept within the following voltage.

VH	: 0V ~ +28V
Vdd	: 0V ~ +6.5V
Other signals	: GND -0V ~ Vdd+0.3V

7.3 The heater and driver ICs are electrostatically sensitive. Care should be taken not to touch connectors with hands or an electrostatically charged object. It is recommended that brushes near the head be provided to discharge electrostatic build up.

7.4 On the surface near the heater, do not apply any hard material. The abrasion resistant layer is fragile to mechanical impact.

7.5 Ink dregs adhered to the heater should be wiped off softly with a soft cloth dipped alcohol or detergent. Do not use sandpaper or equivalent.

7.6 Keep hard particles out of the heater surface. Hard particles may scratch the abrasion resistant layer.

7.7 Maximum number of heaters for simultaneous is 448.

7.8 When the printer is on standby, the thermal head (VH) must be switched off.

Fig. 1 Recommend Connection

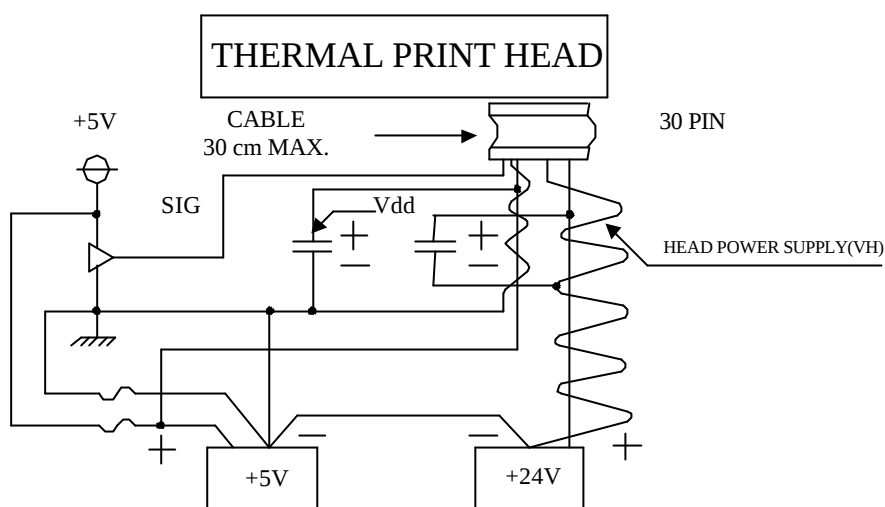


Table. 1 Thermistor

$$R_{25} = 30K\Omega \pm 5\%, B_{CONST} = 3950\text{kelvin} \pm 2\%, R = R_{25}e^{B(1/T - 1/T_{25})}$$

Temperature (° C)	Thermistor Resistance (R)		
	Min .(KΩ)	Typ. (KΩ)	Max. (KΩ)
-40.0	924.3	1048	1184
-35.0	667.4	751.1	843.1
-30.0	487.6	545.0	607.6
-25.0	360.0	399.9	442.9
-20.0	268.8	296.6	326.5
-15.0	202.7	222.3	243.2
-10.0	154.2	168.2	182.9
-5.0	118.4	128.4	138.9
0.0	91.70	98.90	106.4
5.0	71.65	76.71	82.10
10.0	56.20	59.99	63.88
15.0	44.50	47.27	50.10
20.0	35.49	37.53	39.58
25.0	28.50	30.00	31.50
30.0	22.84	24.14	25.46
35.0	18.42	19.55	20.71
40.0	14.95	15.93	16.94
45.0	12.20	13.06	13.94
50.0	10.02	10.76	11.54
55.0	8.271	8.920	9.596
60.0	6.864	7.430	8.021
65.0	5.726	6.219	6.738
70.0	4.799	5.230	5.686
75.0	4.041	4.418	4.819
80.0	3.418	3.749	4.102

Table. 2 C-MOS Driver IC

Table 2.1 Electrical characteristics for driver IC.

Absolute maximum ratings for driver ICs.

Parameter	Symbol	Test conditions	Ratings	Unit
Supply voltage	V_{dd}	Surge	0 ~ 6.5	V
	V_H	Surge	0 ~ 28	V
Input voltage for logic	V_{IN}		0 ~ $V_{dd} + 0.3$	V

Recommended operating conditions

Parameter	Symbol	Test conditions	Recommendations			Unit
			Min.	Typ.	Max.	
Supply voltage	V_{dd}		4.75	5.0	5.25	V
	V_H	Supply voltage for V_H	23.5	24.0	24.5	V
Input voltage for logic	V_{IH}	(Note 1)	$0.8 \times V_{dd}$		V_{dd}	V
	V_{IL}		0		$0.2 \times V_{dd}$	V
Clock frequency	f_{CLK}	duty 50%	0.1	1.0	4	MHz

(Note 1) Recommended driver IC is 74HC244 or equivalent.

Table 2.2 Electrical characteristics for driver IC.

Parameter	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Input current	$\overline{LATCH}$	(Note 1) I_{IH} $V_{dd} = 5.75V$ $V_{IH} = 5.75V$			6.5	μA
	$\overline{STROBE}$				2.0	μA
	CLOCK				6.5	μA
	DATA IN				0.5	μA
	$\overline{LATCH}$	I_{IL} $V_{dd} = 5.75V$ $V_{IL} = 0V$	-6.5			μA
	$\overline{STROBE}$		-220			μA
	CLOCK		-6.5			μA
	DATA IN		-0.5			μA
Output voltage of drivers (Heater supply voltage)	V_{OL}	$V_{dd} = 5V$ $T_j = 0^\circ C$		1.1	1.7	V
		$I_{OL} = 15mA$ $T_j = 70^\circ C$		1.5	2.3	
Leak current of drivers	I_{OH}	$V_{dd} = 4.25V$ $V_H = 24V$			1.0	$\mu A/dot$
Logic supply current	I_{dd}	$V_{dd} = 5.25V$ ALL WHITE $f_{CLK} = 2MHz$			59	mA

(Note 1) Each $\overline{STROBE}$ includes pull-up resistance of $300K\Omega \pm 50\%$ per IC.

Table 2.3 Switching characteristics for driver ICs.

Parameter	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Clock frequency	f_{MAX}				4.0	MHz
Clock pulse width	tw(T)		70			ns
Data setup time	tsu(D)		50			ns
Data hold time	th(D)		40			ns
Latch setup time	tsu(LA)		100			ns
Latch pulse width	tw(LA)		100			ns
Strobe setup time	tsu($\overline{STB}$)		100			ns
Strobe to driver Output delay time	TpLH TpHL				3.5	μ s

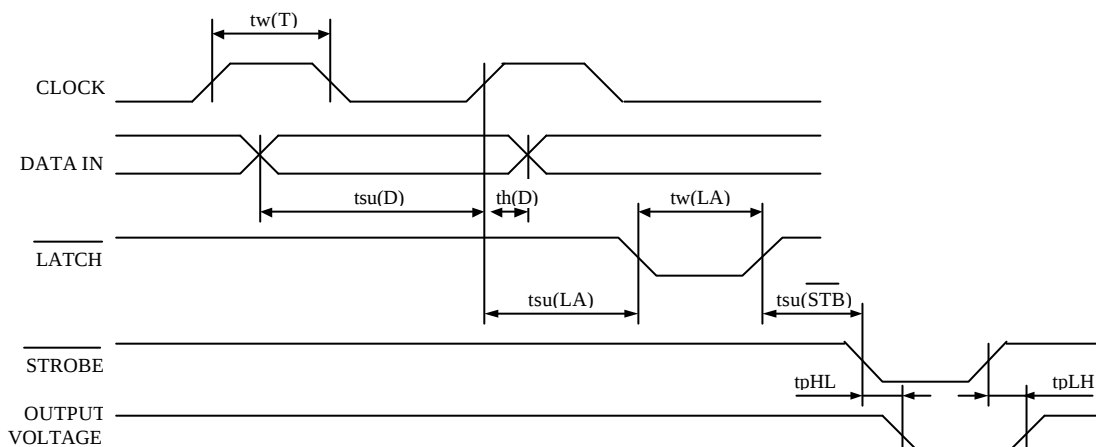


Fig. 2 Thermal Print Head (G104-4I) Timing Chart

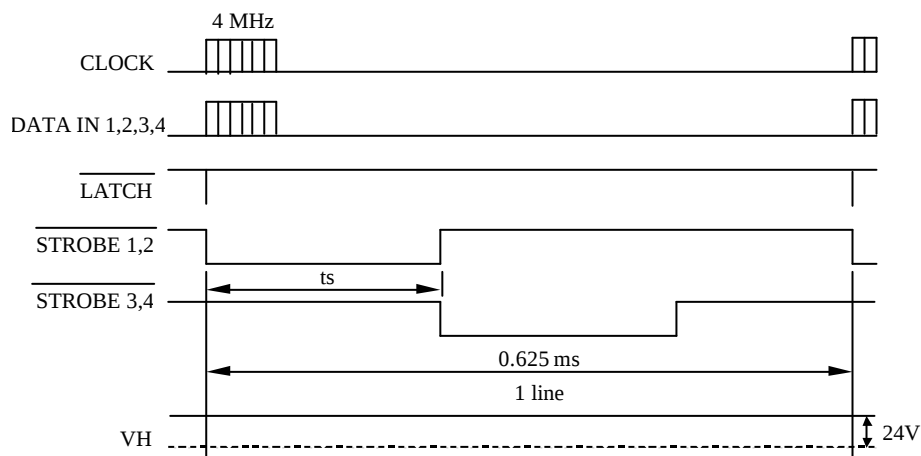


Fig. 3 Schematic Diagram

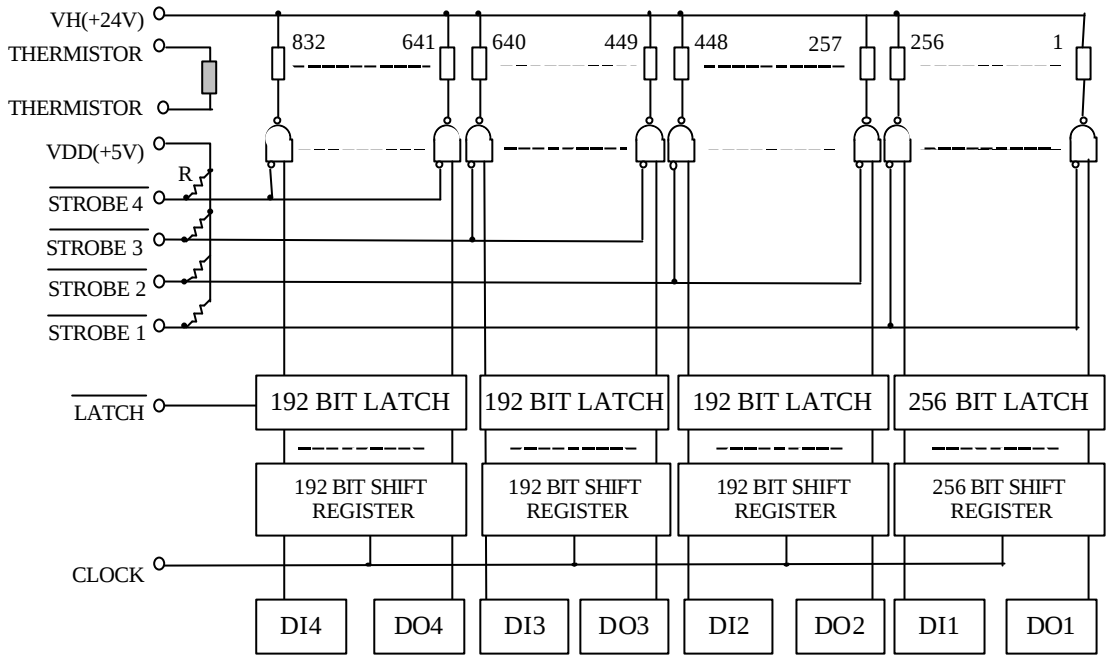


Fig. 4 Cross Section

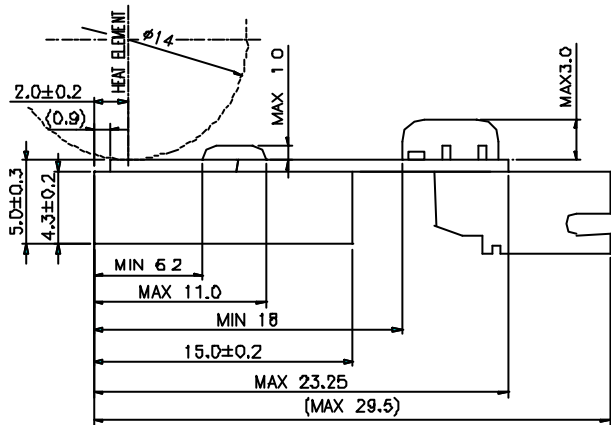


Table. 3 Pin assignment

Connector : (S30B-PHDSS or EQUIVALENT)

PIN	NAME	PIN	NAME	PIN	NAME	PIN	NAME
1	VH	9	DATA IN 2	17	THERMISTOR	25	GND
2	VH	10	DATA OUT 2	18	CLOCK	26	GND
3	GND	11	<u>STROBE 1</u>	19	<u>STROBE 3</u>	27	GND
4	VH	12	<u>STROBE 2</u>	20	<u>STROBE 4</u>	28	VH
5	GND	13	THERMISTOR	21	DATA IN 3	29	VH
6	GND	14	<u>LATCH</u>	22	DATA OUT 3	30	VH
7	DATA IN 1	15	Vdd	23	DATA IN 4		
8	DATA OUT 1	16	NC	24	DATA OUT 4		

Technical drawing of a test specimen showing top, side, and detail views with dimensions and callouts.

Top View Dimensions:

- Overall width: 115.5 ± 0.3
- Inner width: (111.4) (SBSTR SIZE)
- Print width: 104 (PRINT WIDTH)
- Left margin: (5.75)
- Top margin: 2.0 ± 0.2
- Bottom margin: (29.5 MAX)
- Central hole diameter: $\text{DOT } 1$
- Central hole diameter: $\text{DOT } 832$
- Central hole diameter: $\text{DOT } 1$

Side View Dimensions:

- Overall height: 104.0 ± 0.2
- Top margin: 1.50
- Bottom margin: 5.75
- Central hole diameter: $\text{DOT } 1$
- Central hole diameter: $\text{DOT } 832$
- Central hole diameter: $\text{DOT } 1$

Detail View Dimensions:

- Overall width: 115.5 ± 0.3
- Inner width: (111.4) (SBSTR SIZE)
- Print width: 104 (PRINT WIDTH)
- Left margin: (5.75)
- Top margin: 2.0 ± 0.2
- Bottom margin: (29.5 MAX)
- Central hole diameter: $\text{DOT } 1$
- Central hole diameter: $\text{DOT } 832$
- Central hole diameter: $\text{DOT } 1$

Callouts:

- 1: SUBSTRATE
- 2: HEAT SINK
- 3: CIRCUIT BOARD
- 4: CONNECTOR
- 5: ADHESIVE
- 6: EPOXY MOLD
- 7: THERMISTOR
- 8: EPOXY

Table:

ITEM	DESCRIPTION	MATERIAL	DEF	SUMMARY
1	SUBSTRATE	CERAMIC	1	
2	HEAT SINK	ALUMINUM	1	
3	CIRCUIT BOARD	FR4	1	M2VO
4	CONNECTOR		1	S208-PHDS(S) or equivalent
5	ADHESIVE		1	
6	EPOXY MOLD		1	
7	THERMISTOR		1	
8	EPOXY		1	

NOTE:

- COMPOSITION OF LOT No. 1 09 (2001) (Sep)
- IN CASE OF M3 SCREW USED FOR FIXATION, DEPTH IS 3.5 MAX.